

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Anthony M. Andric et al.

Title: METHOD AND APPARATUS FOR DIRECT CONNECTION BETWEEN
TWO INTEGRATED CIRCUITS VIA CONNECTOR

Application No.: 09/824,135 Filed: April 2, 2001

Examiner: J. Vigushin Group Art Unit: 2827

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COMMISSIONER FOR PATENTS
Washington, DC 20231**RESPONSE TO NON-FINAL OFFICE ACTION**

This paper is responsive to a NON-FINAL Office action dated February 10, 2003, having
a shortened statutory period for response set to expire May 10, 2003.

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AMENDMENT

MAR 26 2003

In the Claims

TECHNOLOGY CENTER 2800

20. (Amended) An integrated circuit assembly comprising:
first means for electrically coupling a packaged integrated circuit to a printed circuit
board;
second means for directly electrically coupling the packaged integrated circuit to a
second packaged integrated circuit without coupling through the printed circuit
board.

28. (New) The integrated circuit assembly as recited in claim 20 wherein high speed
signals are routed over the second means and wherein power, ground and slower speed signals
are routed over the first means.